

HD74LV10A

Triple 3-input Positive NAND Gates

REJ03D0233-0300Z (Previous ADE-205-251A (Z)) Rev.3.00 May 24, 2004

Description

The HD74LV10A performs the Boolean functions $Y = \overline{A \cdot B \cdot C}$ or $Y = \overline{A} + \overline{B} + \overline{C}$ in positive logic.

Low-voltage and high-speed operation is suitable for the battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

Features

- $V_{CC} = 2.0 \text{ V}$ to 5.5 V operation
- All inputs V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
- All outputs V_0 (Max.) = 5.5 V (@ V_{CC} = 0 V)
- Typical V_{OL} ground bounce < 0.8 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.3 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Output current ± 6 mA (@V_{CC} = 3.0 V to 3.6 V), ± 12 mA (@V_{CC} = 4.5 V to 5.5 V)
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV10AFPEL	SOP-14 pin(JEITA)	FP-14DAV	FP	EL (2,000 pcs/reel)
HD74LV10ARPEL	SOP-14 pin(JEDEC)	FP-14DNV	RP	EL (2,500 pcs/reel)
HD74LV10ATELL	TSSOP-14 pin	TTP-14DV	Т	ELL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

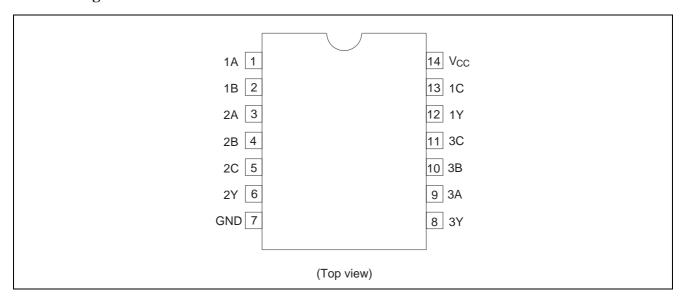
Function Table

Inputs

Α	В	С	Output Y
Н	Н	Н	L
L	Χ	X	Н
X	L	X	Н
X	Χ	L	Н

Note: H: High level L: Low level X: Immaterial

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V _{CC}	-0.5 to 7.0	V	
Input voltage range*1	VI	-0.5 to 7.0	V	
Output voltage range*1, 2	Vo	-0.5 to $V_{CC} + 0.5$	V	Output: H or L
		-0.5 to 7.0		V _{CC} : OFF
Input clamp current	I _{IK}	-20	mA	V _I < 0
Output clamp current	I _{OK}	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	I ₀	±25	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±50	mA	
Maximum power dissipation at	P _T	785	mW	SOP
Ta = 25° C (in still air)* ³		500		TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

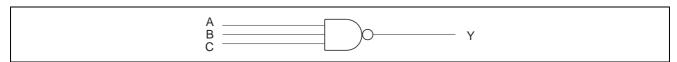
HD74LV10A

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	Vcc	2.0	5.5	V	
Input voltage range	VI	0	5.5	V	
Output voltage range	Vo	0	V _{CC}	V	
Output current	I _{OH}	_	-50	μΑ	$V_{CC} = 2.0 \text{ V}$
		_	-2	mA	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		_	-6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
	I _{OL}	_	50	μΑ	$V_{CC} = 2.0 \text{ V}$
		_	2	mA	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		_	6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt /Δν	0	200	ns/V	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		0	100		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	20		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Logic Diagram



DC Electrical Characteristics

 $Ta = -40 \text{ to } 85^{\circ}C$

Item	Symbol	V _{CC} (V)*	Min	Тур	Max	Unit	Test Conditions
Input voltage	V_{IH}	2.0	1.5	_	_	V	
		2.3 to 2.7	$V_{\text{CC}} \times 0.7$	_	_		
		3.0 to 3.6	$V_{CC} \times 0.7$	_	_		
		4.5 to 5.5	$V_{\text{CC}} \times 0.7$	_	_		
	V _{IL}	2.0	_	_	0.5		
		2.3 to 2.7	_	_	$V_{\text{CC}}\!\times\!0.3$		
		3.0 to 3.6	_	_	$V_{\text{CC}}\!\times\!0.3$		
		4.5 to 5.5	_	_	$V_{\text{CC}}\!\times\!0.3$		
Output voltage	V _{OH}	Min to Max	V _{CC} – 0.1	_	_	V	$I_{OH} = -50 \mu A$
		2.3	2.0	_	_		$I_{OH} = -2 \text{ mA}$
		3.0	2.48	_	_		$I_{OH} = -6 \text{ mA}$
		4.5	3.8	_	_		$I_{OH} = -12 \text{ mA}$
	V _{OL}	Min to Max	_	_	0.1		$I_{OL} = 50 \mu A$
		2.3	_	_	0.4		$I_{OL} = 2 \text{ mA}$
		3.0	_	_	0.44		$I_{OL} = 6 \text{ mA}$
		4.5	_	_	0.55		I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Quiescent supply current	I _{CC}	5.5	_	_	20	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	I _{OFF}	0	_	_	5	μΑ	V_1 or $V_0 = 0$ V to 5.5 V
Input capacitance	C _{IN}	3.3	_	3.5	_	pF	$V_I = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $V_{CC}=2.5\pm0.2\ V$

		Ta =	25°C		$Ta = -40 \text{ to } 85^{\circ}C$		Test		FROM	то
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	8.0	13.0	1.0	15.5	ns	C _L = 15 pF	A, B,	Υ
delay time	t_PHL	_	10.4	17.1	1.0	20.5		$C_L = 50 pF$	or C	

 $V_{CC}=3.3\pm0.3\ V$

		Ta =	25°C		$Ta = -40 \text{ to } 85^{\circ}C$			Test	FROM	то	
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)	
Propagation	t _{PLH}	_	5.7	8.4	1.0	10.0	ns	C _L = 15 pF	А, В,	Υ	
delay time	t_PHL	_	8.2	11.9	1.0	13.5		$C_{L} = 50 \text{ pF}$	or C		

 $V_{CC} = 5.0 \pm 0.5~V$

		Ta =	25°C		$Ta = -40 \text{ to } 85^{\circ}C$			Test	FROM	то
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	3.9	5.9	1.0	7.0	ns	$C_L = 15 pF$	A, B,	Υ
delay time	t _{PHL}	_	5.4	7.9	1.0	9.0		$C_L = 50 pF$	or C	

Operating Characteristics

 $C_L = 50 pF$

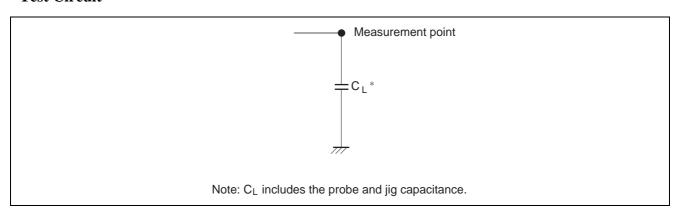
			Ta = 25	5°C					
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test Conditions		
Power dissipation capacitance	C _{PD}	3.3	_	9.5	_	pF	f = 10 MHz		
		5.0	_	11.0	_				

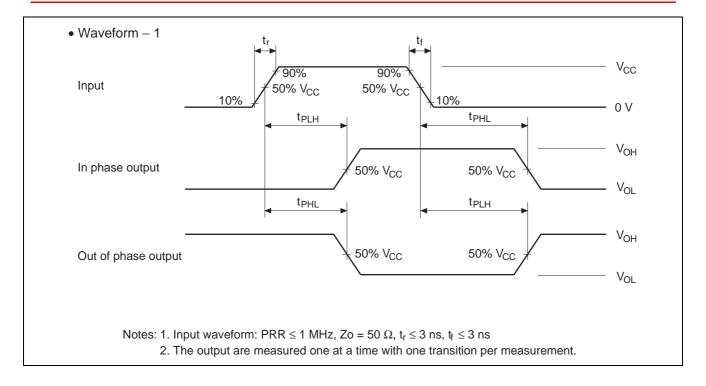
Noise Characteristics

 $C_L = 50 pF$

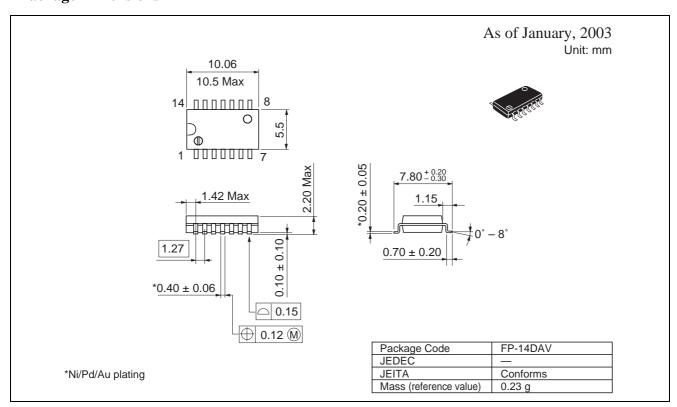
			Ta = 25	Ta = 25°C			
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test Conditions
Quiet output, maximum dynamic V _{OL}	V _{OL (P)}	3.3	_	0.2	0.8	V	
Quiet output, minimum dynamic V _{OL}	V _{OL (V)}	3.3	_	-0.1	-0.8		
Quiet output, minimum dynamic V _{OH}	$V_{OH\ (V)}$	3.3	_	3.2	_		
High-level dynamic input voltage	$V_{\text{IH (D)}}$	3.3	2.31	_	_	V	
Low-level dynamic inout voltage	$V_{IL\ (D)}$	3.3	_	_	0.99		

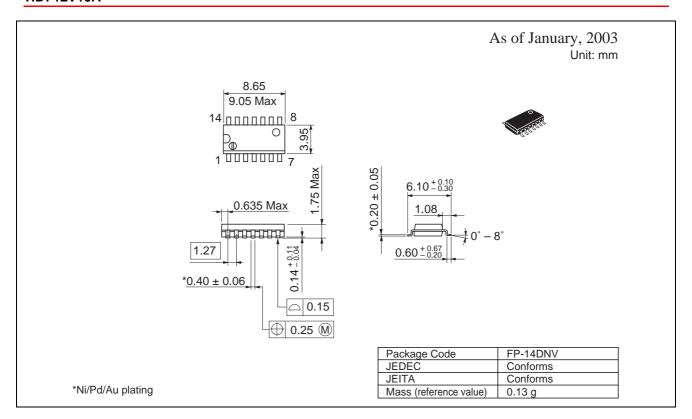
Test Circuit

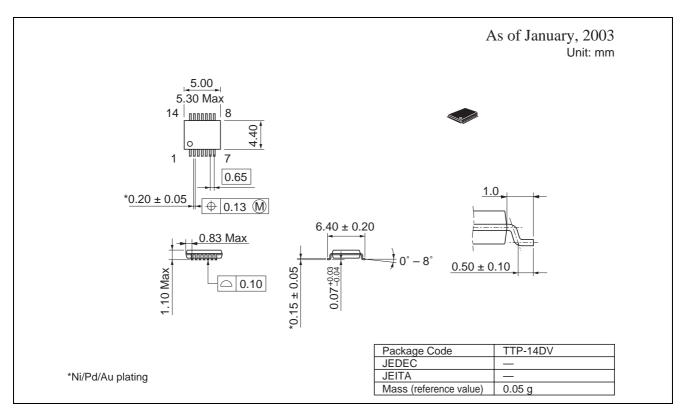




Package Dimensions







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